

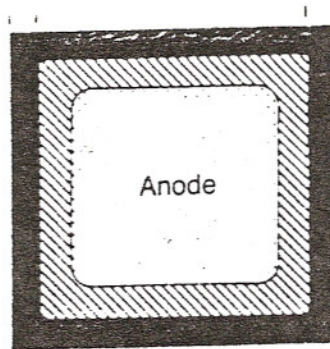


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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.



Backside: Cathode

Topside Metal: Al

Backside: Au

Backside Potential: Cathode

Mask Ref:

Bond Pads (Mils):

APPROVED BY:
MFG: Mirco Semi

DIE SIZE (Mils): 60 x 60
THICKNESS:

DATE: 3/16/00
P/N: CH5367A